



12V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
40)/	$8m\Omega @ V_{GS} = 4.5V$	12.2A
12V	12.5m Ω @ V _{GS} = 2.5V	10.4A

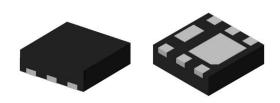
Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Battery Management Application
- Power Management Functions
- DC-DC Converters

U-DFN2020-6 (Type F)



Top View

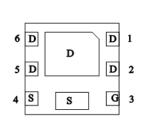
Bottom View

Features

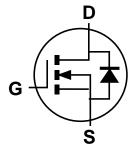
- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- · Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-DFN2020-6 (Type F)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0065 grams (Approximate)



Pin Out Bottom View



Internal Schematic

Ordering Information (Note 4)

Part Number	Reel Size (inches)	Case	Quantity per Reel
DMN1008UFDF-7	7	U-DFN2020-6 (Type F)	3,000
DMN1008UFDF-13	13	U-DFN2020-6 (Type F)	10,000

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



8N = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)

M = Month (ex: 9 = September)

Date Code Key

_	Date Code ite										
	Year	2015	~	2018	2019	2020	2021	2022	2023	2024	2025
	Code	С	~	F	G	Н		J	K	L	M

Moi	nth	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Co	de	1	2	3	4	5	6	7	8	9	0	N	D

April 2018

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	12	V
Gate-Source Voltage			V_{GSS}	±8	V
Continuous Drain Current, V _{GS} = 4.5V (Note 6)	I _D	12.2 9.8	А		
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%	(a)		I _{DM}	60	A
Continuous Source-Drain Diode Current (Note 6)	Is	1.8	Α		
Avalanche Current, L = 0.1mH (Note 7)	I _{AS}	16.4	Α		
Avalanche Energy, L = 0.1mH (Note 7)			E _{AS}	13.5	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	D-	0.7	W
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_D	0.4	VV
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	168	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	D	1.7	W
Total Power Dissipation (Note 6)	T _A = +70°C	P _D	1.0	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	74	°C/W
Thermal Resistance, Junction to Case (Note 6)		R ₀ JC	12	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

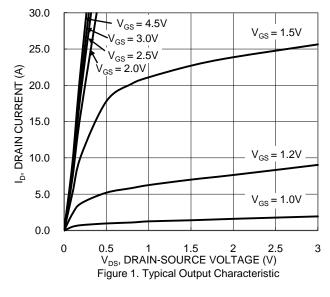
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)				1	ı		
Drain-Source Breakdown Voltage	BV _{DSS}	12	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1	μA	$V_{DS} = 9.6V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.3		1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
			6.6	8		$V_{GS} = 4.5V, I_{D} = 5A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	7.6	11	mΩ	$V_{GS} = 3.0V, I_D = 5A$	
			8.5	12.5		$V_{GS} = 2.5V, I_D = 5A$	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 5A$	
DYNAMIC CHARACTERISTICS (Note 9)		•				•	
Input Capacitance	C _{iss}	_	995	_		$V_{DS} = 6V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	Coss	_	305	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	270	_		1 = 1.0IVII IZ	
Gate Resistance	Rg	_	1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	13.6	_			
Total Gate Charge (V _{GS} = 8V)	Qg	_	23.4	_	nC		
Gate-Source Charge	Q _{gs}	_	1.3	_	IIC	$V_{DS} = 6V$, $I_D = 5A$	
Gate-Drain Charge	Q_{gd}	_	3.3	_			
Turn-On Delay Time	t _{D(ON)}	_	3.5	_			
Turn-On Rise Time	t _R	_	6.6	_		$V_{DS} = 6V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	17.5	_	ns	$R_G = 2\Omega$, $I_D = 5A$	
Turn-Off Fall Time	t _F	_	7.5	_			
Reverse Recovery Time	t _{RR}	_	15	_	ns	I _F = 5A, di/dt = 200A/μs	
Reverse Recovery Charge	Q _{RR}	_	4	_	nC	$I_F = 5A$, di/dt = 200A/ μ s	

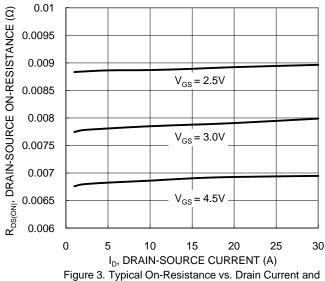
Notes

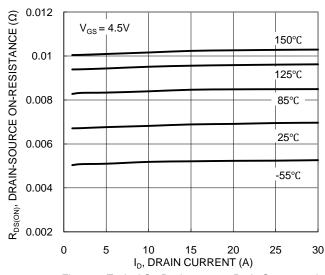
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.





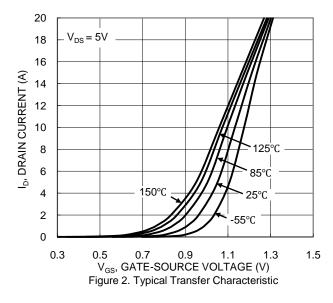


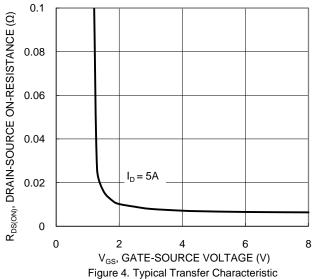




Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





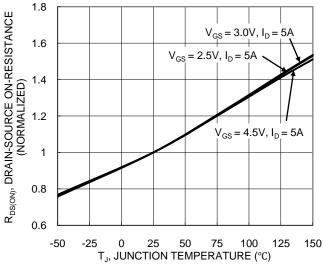
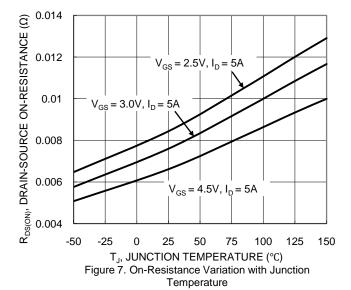
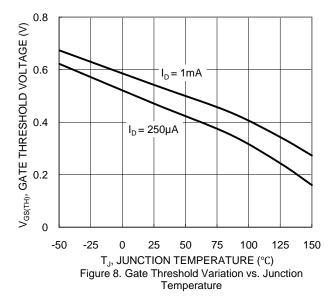


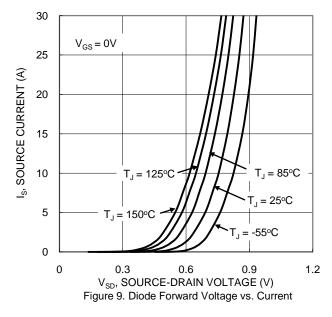
Figure 6. On-Resistance Variation with Junction Temperature

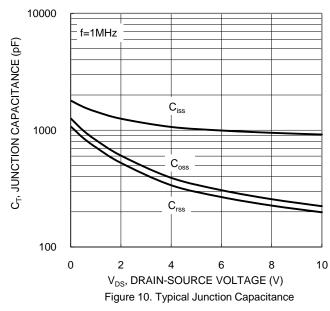


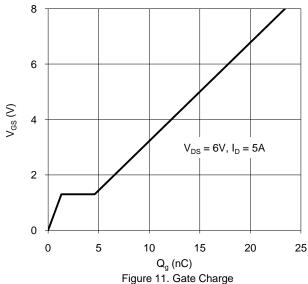


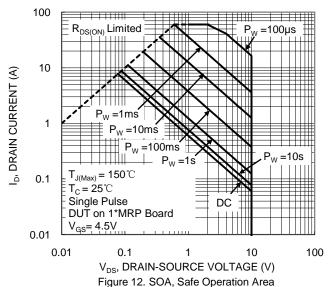














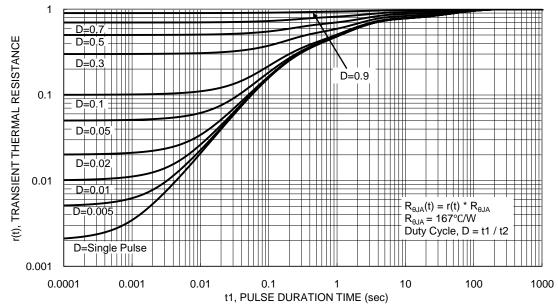


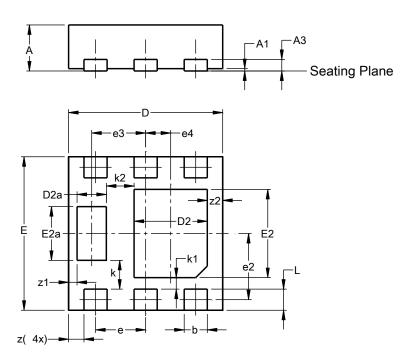
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)

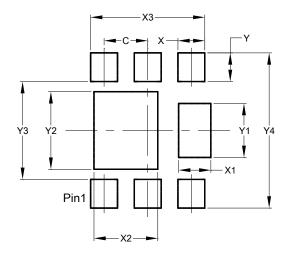


U-DFN2020-6 (Type F)								
Dim								
Α	0.57							
A1	0.00 0.05 0.0							
A3	-	-	0.15					
b	0.25	0.35	0.30					
D	1.95	2.05	2.00					
D2	0.85	1.05	0.95					
D2a	0.33	0.43	0.38					
Е	1.95	2.05	2.00					
E2	1.05	1.25	1.15					
E2a	0.65	0.75	0.70					
е		0.65 BS	С					
e2).863 BS						
е3		0.70 BS	С					
e4	().325 BS	SC					
k		0.37 BS						
k1	0.15 BSC							
k2		0.36 BS						
L		0.325						
Z	0.20 BSC							
z 1).110 BS						
z2		0.20 BS	С					
All C	Dimens	ions in	mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type F)



Dimensions	Value
Dillielisions	(in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
Х3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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